

## **LTspice Model Fast Recovery Diode** NIEC **KSF30A60B**

### **Model Information**

Model A macro model based on general SPICE diode model Call Name MDC KSF30A60B LT **Pin Assian** 1:A 2:C 3:A 4:C File List Model Library MDC\_KSF30A60B\_LT01.lib Model Report MDC\_KSF30A60B\_LT.pdf (this file)

**Verified Simulator Version** Note

LTspice version XVII

#### References

The information which was used for modeling is as follow:

Product name

Characteristics

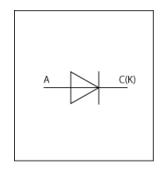
[Data Sheet] Date/Version

v01 KSF30A60B Company name Nihon Inter Electronics Corporation IfVf[Temp],IrVr[Temp],Trr

#### Simulation Range

This table shows the range of evaluated simulation range that was not occurs any convergence problems in this area.

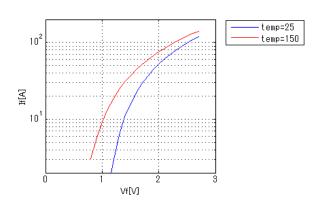
Item	Range			Unit
	Min.		Max.	
Forward Voltage	0	to	27	V
Reverse Voltage	0	to	1,200	V
Temperature	-40	to	150	deg C





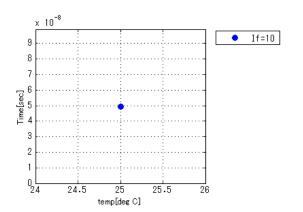
# Simulation results are following. Explanatory notes -: simulated

### lfVf[Temp]



IrVr[Temp]

Trr





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